

### Surface Mount Superfast Recovery Rectifier

Reverse Voltage – 50 to 600 V

Forward Current – 2 A

#### FEATURES

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Superfast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directives

#### MECHANICAL DATA

- Case: SMAF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 27mg / 0.00095oz

#### PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Top View  
Marking Code:  
ES2AF~ES2JF: ES2A~ES2J  
Simplified outline SMAF and symbol

#### Absolute Maximum Ratings and Characteristics

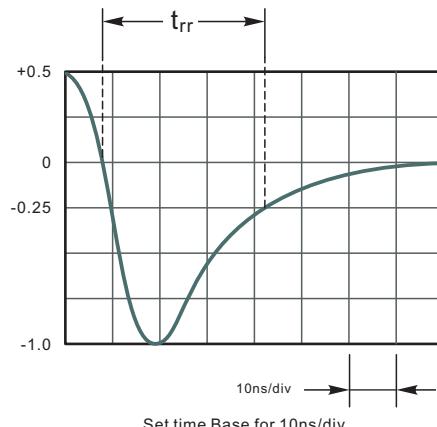
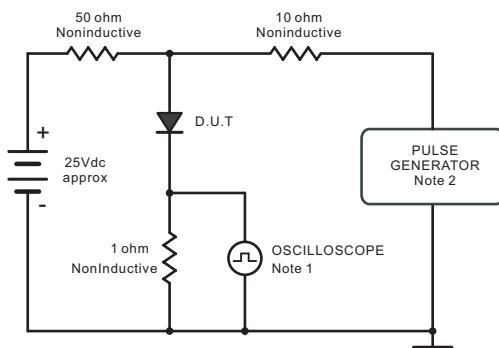
Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Parameter	Symbols	ES2AF	ES2BF	ES2CF	ES2DF	ES2EF	ES2GF	ES2JF	Units
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	50	100	150	200	300	400	600	V
Maximum RMS voltage	V <sub>RMS</sub>	35	70	105	140	210	280	420	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	150	200	300	400	600	V
Maximum Average Forward Rectified Current at T <sub>c</sub> = 125 °C	I <sub>F(AV)</sub>					2			A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	I <sub>FSM</sub>					50			A
Maximum Forward Voltage at 2 A	V <sub>F</sub>			1			1.25	1.68	V
Maximum DC Reverse Current T <sub>a</sub> = 25 °C at Rated DC Blocking Voltage T <sub>a</sub> = 125 °C	I <sub>R</sub>			5		100			µA
Typical Junction Capacitance at V <sub>R</sub> =4V, f=1MHz	C <sub>j</sub>			30					pF
Maximum Reverse Recovery Time <sup>(1)</sup>	t <sub>rr</sub>			35					ns
Typical Thermal Resistance <sup>(2)</sup>	R <sub>θJA</sub> R <sub>θJC</sub>			65		20			°C/W
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>stg</sub>			-55 ~ +150					°C

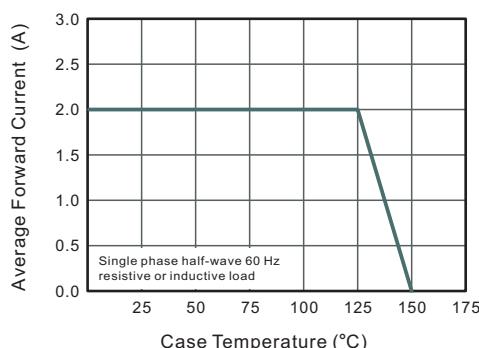
( 1 ) Measured with I<sub>F</sub> = 0.5 A, I<sub>R</sub> = 1 A, I<sub>rr</sub> = 0.25 A.

( 2 ) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

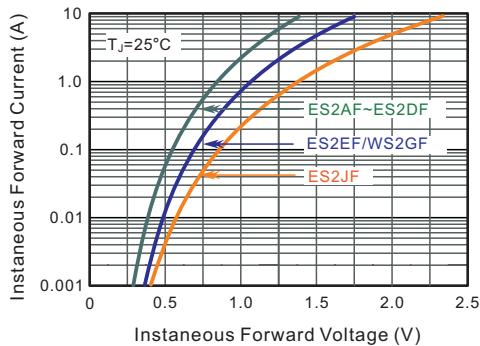
**Fig.1 Reverse Recovery Time Characteristic And Test Circuit Diagram**



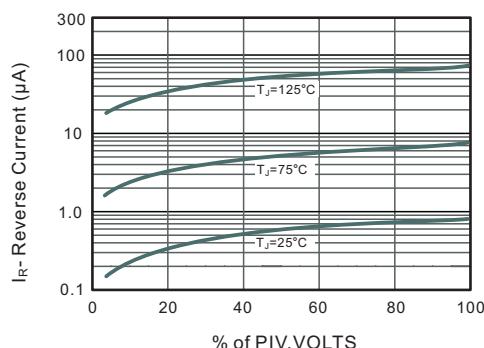
**Fig.2 Maximum Average Forward Current Rating**



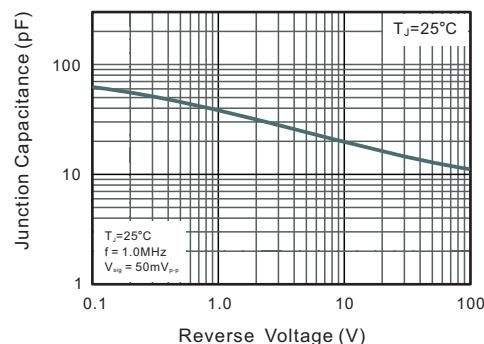
**Fig.4 Typical Forward Characteristics**



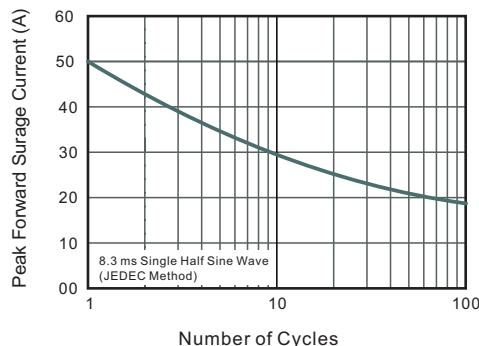
**Fig.3 Typical Reverse Characteristics**



**Fig.5 Typical Junction Capacitance**



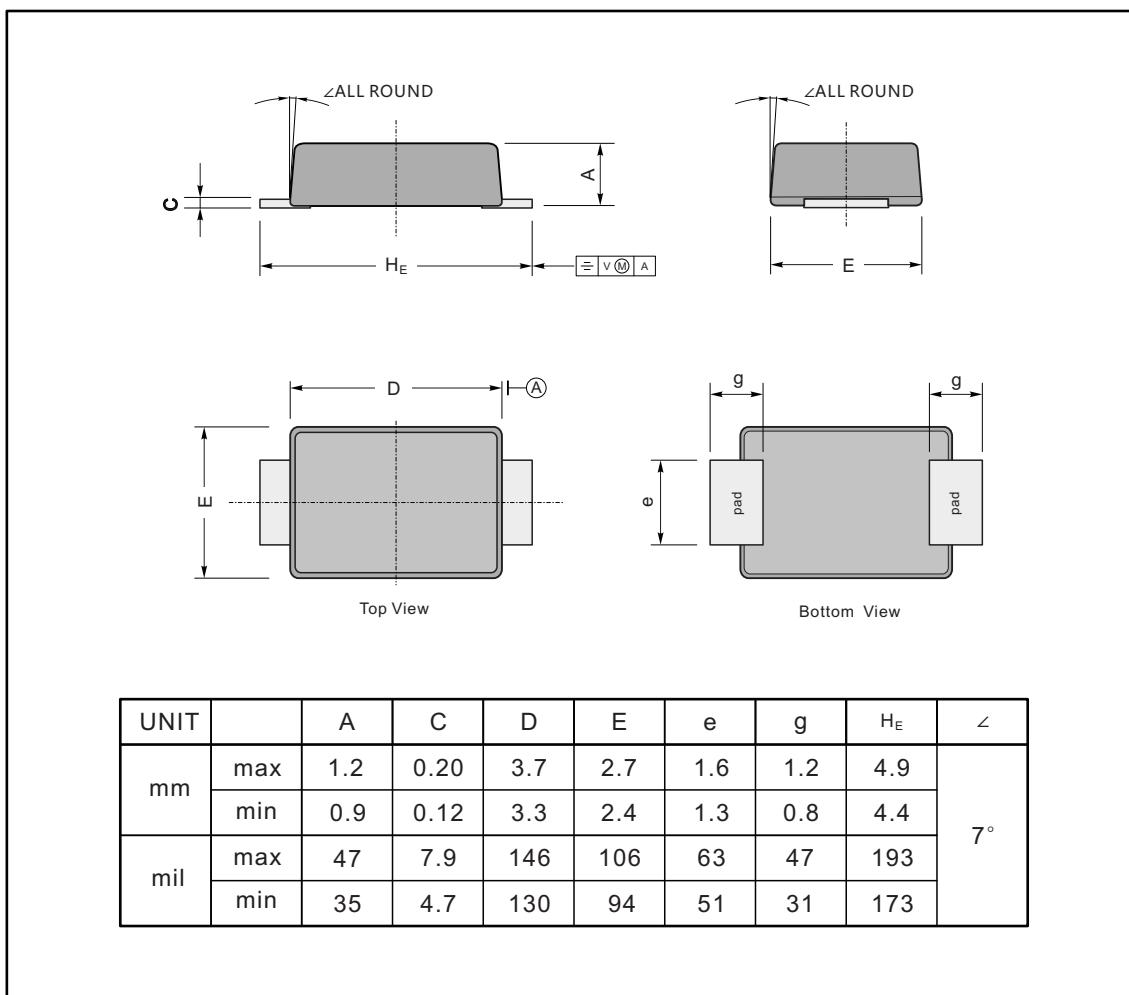
**Fig.6 Maximum Non-Repetitive Peak Forward Surge Current**



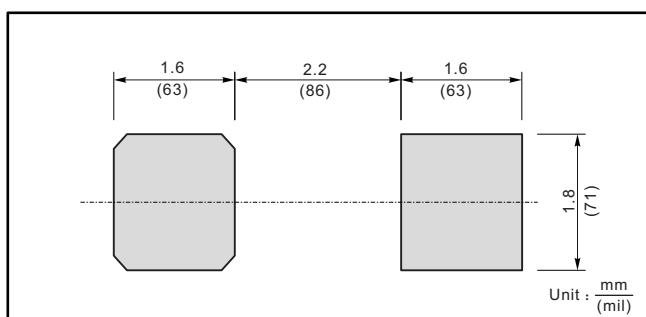
### PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SMAF



### The recommended mounting pad size



### Marking

Type number	Marking code
ES2AF	ES2A
ES2BF	ES2B
ES2CF	ES2C
ES2DF	ES2D
ES2EF	ES2E
ES2GF	ES2G
ES2JF	ES2J